## INTRODUCTION:

Adam Tech SMT PLCC Series Sockets are low profile, thin wall sockets designed to convert plastic leaded chips to a thru-hole PCB format on a . 100" centerline grid. They conform to all applicable EIA and JEDEC standards. Adam Tech's superior precision stamped contact design provides consistent, high retention contacts for all size chips. Chip exchanges or replacements are easily made with Adam Tech's chip remover part no. PLCC-EXT.

## FEATURES:

Full range of sizes from 20P ~ 100P
Consistent, uniform high retention contacts
Compatible with wide range of chip sizes
No solder wicking design
Hi Temp PPS insulator
Open frame design for viewable solder joints

## MATING PLASTIC LEADED CHIPS:

All EIA / JEDEC compliant PLCC

## SPECIFICATIONS:

## Material:

Standard Hi-Temp insulator: PPS, Glass reinforced, rated UL94V-0 Insulator Color: Brown
Contacts: Phosphor Bronze

## Contact Plating:

Tin over copper underplate overall
Electrical:
Operating voltage: 250V AC max.
Current rating: 1 Amp max.
Contact resistance: $30 \mathrm{~m} \Omega$ max. initial
Insulation resistance: $1000 \mathrm{M} \Omega \mathrm{min}$.
Dielectric withstanding voltage: 500V AC for 1 minute
Mechanical:
Insertion force: 6.35 oz max.
Withdrawal force: 1.0 oz min
Temperature Rating:
Operating temperature: $-55^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$
Soldering process temperature: $260^{\circ} \mathrm{C}$

## PACKAGING:

Anti-ESD plastic tubes

## APPROVALS AND CERTIFICATIONS:

UL Recognized File No. E224053
CSA Certified File No. LR1578596


## ORDERING INFORMATION



OPTIONS:
Add designator(s) to end of part number
P = With polarizing pegs
TR = Tape and reel packaging

PLCC SOCKETS PLASTIC LEADED CHIP CARRIER SOCKET SURFACE MOUNT PLCC SERIES



Adam Technologies, Inc. PLASTIC LEADED CHIP CARRIER SOCKET

THRU-HOLE
PLCC SERIES

## INTRODUCTION:

Adam Tech PLCC Series Sockets are designed to convert plastic leaded chips to a thru-hole PCB format on a .100" centerline grid. They conform to all applicable EIA and JEDEC standards. Adam Tech's superior precision stamped contact design provides consistent, high retention contacts for all size chips. Chip exchanges or replacements are easily made with Adam Tech's chip remover part no. PLCC-EXT

## FEATURES:

Full range of sizes from 20P ~ 100P Consistent, uniform high retention contacts
Compatible with wide range of chip sizes
No solder wicking design
Hi Temp PPS insulator version available

MATING PLASTIC LEADED CHIPS:
All EIA / JEDEC plastic leaded chips

## SPECIFICATIONS

## Material:

Standard Insulator: PBT, Glass reinforced, rated UL94V-0
Optional Hi-Temp insulator: PPS
Insulator Color: Black (Brown for PPS)
Contacts: Phosphor Bronze

## Contact Plating:

Tin over copper underplate overall
Electrical:
Operating voltage: 250V AC max.
Current rating: 1 Amp max.
Contact resistance: $30 \mathrm{~m} \Omega$ max. initial
Insulation resistance: $1000 \mathrm{M} \Omega \mathrm{min}$.
Dielectric withstanding voltage: 500V AC for 1 minute
Mechanical:
Insertion force: 6.35 oz max.
Withdrawal force: 1.0 oz min

## Temperature Rating:

Operating temperature: $-55^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$
Soldering process temperature:
Standard insulator: $235^{\circ} \mathrm{C}$
Hi-Temp insulator: $260^{\circ} \mathrm{C}$

## PACKAGING:

Anti-ESD plastic tubes

## APPROVALS AND CERTIFICATIONS:

UL Recognized File No. E224053
CSA Certified File No. LR1578596


HI-TEMP
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ORDERING INFORMATION


PEC INDICATOR
PLCC = Plastic Leaded
Chip Carrier Socket
AT $=$ Tin-plated
AG = Gold-plated

CONTACTS
$20,28,32,44,52,68,84,100$

OPTIONS:
Add designator(s) to end of part number
HT = Hi-Temp Polyphenylene Sulfide (PPS) Insulator Material for hi-temp soldering process up to $260^{\circ} \mathrm{C}$

| PLCC-20-AT |  | Recommended PCB Layout |
| :---: | :---: | :---: |
| PLCC-28-AT |  | Recommended PCB Layout |
| PLCC-32-AT |  | Recommended PCB Layout |
| PLCC-44-AT |  | Recommended PCB Layout |



